Freescale Semiconductor

Technical Data

CATV Amplifier Module

Features

- Specified for 128-Channel Loading
- Excellent Distortion Performance
- · Silicon Bipolar Transistor Technology
- Unconditionally Stable Under All Load Conditions

Applications

- CATV Systems Operating in the 40 to 870 MHz Frequency Range
- Input Stage Amplifier in Optical Nodes, Line Extenders and Trunk Distribution Amplifiers for CATV Systems
- Driver Amplifier in Linear General Purpose Applications
- Output Stage Amplifier on Applications Requiring Low Power Dissipation

Description

- 24 Vdc Supply, 40 to 870 MHz, CATV Forward Amplifier Module
- Replaced MHW8272A. There are no form, fit or function changes with this
 part replacement.
- RoHS Compliant

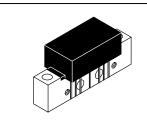
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√RoHS

MHW8272AN

870 MHz 27.7 dB GAIN 128-CHANNEL CATV AMPLIFIER MODULE



CASE 1302-01, STYLE 1

Table 1. Maximum Ratings

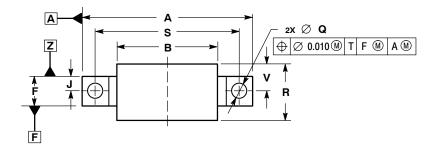
Rating	Symbol	Value	Unit
RF Voltage Input (Single Tone)	V _{in}	+55	dBmV
DC Supply Voltage	V _{CC}	+28	Vdc
Operating Case Temperature Range	T _C	-20 to +100	°C
Storage Temperature Range	T _{stg}	-40 to +100	°C

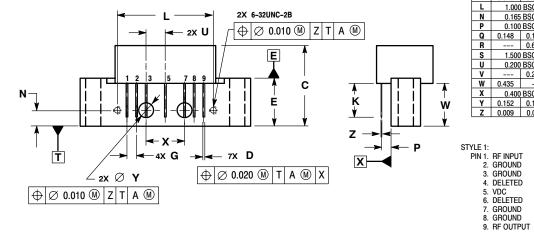
Table 2. Electrical Characteristics (V_{CC} = 24 Vdc, T_{C} = +30°C, 75 Ω system unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Frequency Range		BW	40	_	870	MHz
Power Gain	50 MHz 870 MHz	G _p	26.2 27	27.2 27.7	27.8 29.5	dB
Slope	40 - 870 MHz	S	0	0.6	2	dB
Gain Flatness (40 - 870 MHz, Peak to Valley)		G _F	_	0.4	0.8	dB
Return Loss — Input/Output (Z ₀ = 75 Oh	ms) @ 40 MHz @ f > 40 MHz (Derate)	IRL/ORL	20 —	_ _	 0.007	dB dB/MHz
Composite Second Order (V _{out} = +38 dBmV/ch., Worst Case)	128-Channel FLAT	CSO ₁₂₈	_	-69	- 64	dBc
Cross Modulation Distortion @ Ch 2 (V _{out} = +38 dBmV/ch., FM = 55 MHz)	128-Channel FLAT	XMD ₁₂₈	_	-65	- 62	dBc
Composite Triple Beat (V _{out} = +38 dBmV/ch., Worst Case)	128-Channel FLAT	CTB ₁₂₈	_	-69	- 64	dBc
Noise Figure	50 MHz 870 MHz	NF	_ _	 6.0	5.5 7.0	dB
DC Current (V _{DC} = 24 V, T _C = 30°C)		I _{DC}	280	310	350	mA

NOTES

PACKAGE DIMENSIONS





	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α		1.775		45.085	
В		1.085		27.559	
C		0.840		21.336	
D	0.015	0.021	0.381	0.533	
Е	0.465	0.510	11.811	12.954	
F	0.300	0.325	7.62	8.255	
G	0.100	BSC	2.540 BSC		
J	0.156 BSC		3.962 BSC		
K	0.315	0.355	8.001	9.017	
L	1.000 BSC		25.400 BSC		
N	0.165 BSC		4.191 BSC		
P	0.100	BSC	2.540 BSC		
Q	0.148	0.168	3.759	4.267	
R		0.600		15.24	
S	1.500 BSC		38.100 BSC		
U	0.200 BSC		5.080 BSC		
٧		0.250		6.350	
W	0.435		11.049		
Х	0.400 BSC		10.160 BSC		
Υ	0.152	0.163	3.861	4.140	
Z	0.009	0.011	0.229	0.279	

CASE 1302-01 ISSUE E

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